ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declaration er	on of the su	bstances v all lower	vithin the manufactu level materials for w	rer listed i which the r	tem. Note: i nanufacture	f the item is an as r has engineering	ssembly with low responsibility.	
			Form Type Distribute					ials and Mfg Information						
upplier Information														
Company name* Cor			Company unique ID			Unique ID Authority				Respon	Response Date*			
onsemi										2023-06	2023-06-08			
Difference Title - Contact			ct			Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Envi			viro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Represe			esentative			Phone - Representative*			Email - Representative*					
Product-Env-Stewards Product			roduct Enviro Compliance			NA				Produc	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	Version	М	lanufacturing Site		Weight*	UOM	Unit Type	
	FODM1	FODM121AR2V 4SO TR T&		&R VDE		2023-06-08		L	LITEONFG		74.9354	mg	Each	
Ianufacturing Proccess Informa	tion													
Terminal Plating / Grid Array M	aterial T	Ferminal Base	Alloy J-STD-020 MSL Rati		Rating	Peak Proce	cess Body Temperature Max Time at Pea		k Tempera	ture Numb	per of Reflow Cyc	cles		
Matte Tin (Sn) - annealed CU All		CU Alloy	1			260	С 30		30	secor	seconds 3			
omments														
vel 1 - maximum time at peak temperat	ure during so	Idering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	4.9	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		2.205	mg
			Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.49	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		2.205	mg
Die	0.1124	mg	В	Gallium Arsenide (AsGa)	1303-00-0		0.0365	mg
			Supplier	Silicon (Si)	7440-21-3		0.0759	mg
Die Attach	0.17	mg	Supplier	Silver (Ag)	7440-22-4		0.1326	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.0374	mg
Lead Frame	20.6	mg	Supplier	Silver (Ag)	7440-22-4		0.0021	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0247	mg
			Supplier	Iron (Fe)	7439-89-6		0.4738	mg
			Supplier	Copper (Cu)	7440-50-8		20.0932	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0062	mg
Mold Compound-Black	27.9	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		3.627	mg
			Supplier	Carbon Black (C)	1333-86-4		0.279	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		2.511	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		19.53	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		1.953	mg
Mold Compound-White	21.1	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		4.22	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		14.77	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		2.11	mg
Plating	0.1	mg	Supplier	Tin (Sn)	7440-31-5		0.1	mg
Wire Bond - Au	0.053	mg	Supplier	Gold (Au)	7440-57-5		0.053	mg